2SD0968A (2SD968A)

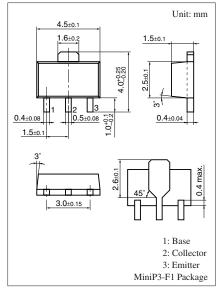
Silicon NPN epitaxial planar type

For low-frequency driver amplification Complementary to 2SB0789A (2SB789A)

Features

- \bullet High collector-emitter voltage (Base open) V_{CEO}
- \bullet Large collector power dissipation $P_{\rm C}$
- Mini power type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing

Absolute Maximum Ratings $T_a = 25^{\circ}C$ Symbol Parameter Rating Unit V 120 Collector-base voltage (Emitter open) V_{CBO} V Collector-emitter voltage (Base open) V_{CEO} 120 Emitter-base voltage (Collector open) 5 V V_{EBO} Peak collector current I_{CP} 1 Α Collector current I_C 0.5 А 1 W Collector power dissipation * P_C Junction temperature Ti 150 °C °C Storage temperature T_{stg} -55 to +150



Marking Symbol: V

Note) *: Print circuit board: Copper foil area of 1 cm² or more, and the board thickness of 1.7 mm for the collector portion.

Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Мах	Unit
Collector-emitter voltage (Base open)	V _{CEO}	$I_{C} = 100 \ \mu A, I_{B} = 0$	120			V
Emitter-base voltage (Collector open)	V _{EBO}	$I_{\rm E} = 10 \ \mu A, \ I_{\rm C} = 0$	5			V
Forward current transfer ratio *1	h _{FE1} *2	$V_{CE} = 10 \text{ V}, I_C = 150 \text{ mA}$	130		330	
	h _{FE2}	$V_{CE} = 5 \text{ V}, \text{ I}_{C} = 500 \text{ mA}$	50			
Collector-emitter saturation voltage *1	V _{CE(sat)}	$I_{\rm C} = 500 \text{ mA}, I_{\rm B} = 50 \text{ mA}$		0.2	0.6	V
Base-emitter saturation voltage *1	V _{BE(sat)}	$I_{\rm C} = 500 \text{ mA}, I_{\rm B} = 50 \text{ mA}$		0.85	1.20	V
Transition frequency	f _T	$V_{CB} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$		120		MHz
Collector output capacitance	C _{ob}	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$			20	pF
(Common base, input open circuited)						

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

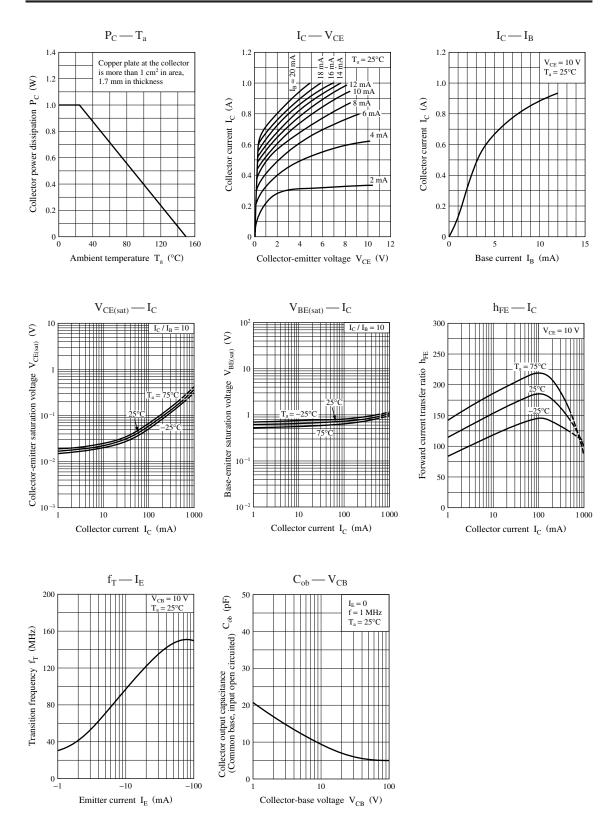
2. *1: Pulse measurement

*2: Rank classification

Rank	R	S
h _{FE1}	130 to 220	185 to 330

Note) The part numbers in the parenthesis show conventional part number.

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